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Mostafa Hassani-Gangaraj, David Veysset, Keith A. Nelson, and Christopher A. Schuh Phys. Rev. Lett. **119**, 175701 — Published 25 October 2017 DOI: 10.1103/PhysRevLett.119.175701

## Melting Can Hinder Impact-Induced Adhesion

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#### 8

# 9 Abstract

Melting has long been used to join metallic materials, from welding to selective laser melting in additive 10 11 manufacturing. In the same school of thought, localized melting has been generally perceived as an advantage, if not the main mechanism, for adhesion of metallic microparticles to substrates during 12 13 supersonic impact. Here, we conduct the first *in-situ* supersonic impact observations of individual 14 metallic microparticles aimed at the explicit study of melting effects. Counter-intuitively, we find that 15 under at least some conditions melting is disadvantageous and hinders impact-induced adhesion. In the parameter space explored, i.e.  $\sim 10 \ \mu m$  particle size and  $\sim 1 \ km/s$  particle speed, we argue that the 16 17 solidification time is much longer than the residence time of the particle on the substrate, so that re-18 solidification cannot be a significant factor in adhesion.

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#### 20 Text

21 Understanding materials physics under impact has motivated extensive research in areas ranging from 22 asteroid strikes [1] and ballistic deposition [2] to mechanochemical synthesis [3], materials failures [4,5], 23 structural modification [6] and phase transformation [7]. Less conventionally, three decades ago, metallic powder particles were first observed to bond to metallic substrates under supersonic-impact conditions at 24 25 low temperatures [8]. The notion of impact-induced adhesion, thereafter, has been implemented in 26 powder processing through kinetic deposition or cold spray [9,10]. Kinetic deposition has proven successful in making coatings [11–13], in reclaiming damaged metallic surfaces [14], and in additively 27 28 manufacturing bulk metallic materials [15].

29 In this area of impact science, researchers have repeatedly observed a material-dependent critical 30 velocity [16,17], a threshold above which supersonic particles change their mode of interaction with the substrate from rebound to adhesion. A variety of proposals including adiabatic shear instability [16], 31 32 oxide layer break-up [18], diffusion [19] and localized melting [20] have been put forth to explain the underlying mechanism(s) of impact-induced adhesion, each of which enjoys partial support from 33 34 observational data. For instance, sharp jumps observed in temperature and strain in Lagrangian impact 35 simulations have been used to support an argument for adiabatic shear localization [16,21]. Experimental measurements of reduced oxide content in cold spray coatings as compared to initial powder feedstock 36 37 underpins an argument for oxide layer break-up [22]. Small spherical ejecta found in the coating [20] or 38 intermetallic detected at the interface [23] suggest localized melting or interdiffusion.

More consensus, however, has been attained around post-mortem observations of material jets around the periphery of adhered particles [16,24,25]. We have recently, for the first time, conducted *in-situ* observations of the impact behavior of individual supersonic metallic microparticles below and above the critical velocity and found that material ejection and jetting are crucial for adhesion [26]. We argued that

43 neither shear localization nor melting are needed to account for material ejection. Rather, it can arise from

the interaction of the impact-induced pressure wave with the contact periphery of the particle. As a result,
we found that the critical adhesion velocity is directly related to the bulk speed of sound [26]. In our
view, the key feature is a fast-traveling pressure wave that drives material ejection and jetting when it
interacts with the leading edge of an impacting particle just a few nanoseconds after the first contact.
Subsequently, oxide layer break-up, shear localization, melting and resultant viscous flow might be, in
fact, trailing consequences of extensive jetting.

50 Our focus on impact-induced-adhesion being a pressure-driven phenomenon therefore generally suggests 51 that temperature rise—and by extension melting—need not adopt a critical importance in this context. 52 The purpose of the present work is to take an additional significant step forward in this line of reasoning, 53 by targeting the process of impact melting specifically to evaluate its role in adhesion. Our approach in 54 conducting impact adhesion experiments differs from the more common use of spray nozzles, which 55 includes many complex variables that we wish to eliminate from consideration. For example, in a typical 56 experiment where expansion of a hot carrier gas accelerates thousands of particles together, the complex

- 57 heat transfer and particle interactions lead to a general lack of specific knowledge on individual particles'
- velocity, size and temperature at the point of impact.

Here, on the other hand, we use an in-house-designed microscale ballistic test platform to accelerate 59 60 individual micrometer-size metallic particles with well-defined size and well-controlled temperature, to 61 have them impact a substrate, and to record the entire deformation, rebound or adhesion process in real 62 time. What is more, our approach allows us to make a one-to-one correspondence between our postmortem observations of the adhered particles/impact residue and the instant of impact. As shown 63 64 schematically in Fig. 1(a), a laser excitation pulse is focused onto a launching pad assembly on top of which metallic particles are sitting. Through ablation of a gold layer and rapid expansion of an 65 66 elastomeric polyurea film, single particles are launched toward a metallic substrate. We use a high-framerate camera and a synchronized quasi-cw laser imaging pulse to observe the particle approach and impact 67 on the substrate in real time. More details regarding the launching pad assembly preparation, the optical 68 setup, and the image analysis have been reported [27]. 69

70 Figure 1(b) shows some exemplar *in-situ* images that we captured for individual supersonic microparticle impacts. The top image series shows a 15- $\mu$ m Al particle as it approaches a Zn substrate, impacts it at 950 71 72 m/s, and undergoes extensive plastic deformation evidenced by the flattening of the rebounding particle. The bottom image series, on the other hand, shows a 15-um Al particle impacting an Al substrate with 73 74 virtually the same velocity but adhering to the substrate. We have conducted many such experiments with a wide range of impact velocities for Al impact on Al, Zn impact on Zn, and Al impact on Zn. We 75 76 measured the rebound and impact velocities for each impact and calculated the ratio between the two, known as the coefficient of restitution (CoR). Figure 1(c) shows the CoR as a function of impact velocity. 77 78 The apparent linear decrease in the coefficient of restitution is followed by a sharp decline to zero, 79 indicating particle adhesion, for Al and Zn particles impacting matched materials. This reveals the 80 existence of the critical velocity for adhesion for these cases.

- In contrast, for Al impacting on Zn, we have never observed a single Al particle adhering to Zn even at very high impact velocities, close to 1400 m/s. While the Al-on-Al and Zn-on-Zn data points deviate from linearity in a concave-downward fashion and fall to zero with many clear observations of adhesion, the Al-on-Zn data points deviate from linearity in a concave-upward fashion instead. They apparently plateau
- at a roughly constant non-zero CoR value at the high velocity range. Although these velocities are far
- beyond the critical adhesion velocity for both of the two constituent metals, there is apparently no critical
- 87 adhesion velocity, at least over the studied range, for the mismatched Al/Zn pair. For a second, similar

- 88 mismatched pair (Al impacting Sn, see Fig. SM1 in Supplemental Material [28]) we see the same effect
- 89 but to even higher velocities.
- 90



92 FIG. 1. *In situ* observation of microparticle supersonic impact. (a) Experimental platform for 93 microparticle impact test and real-time imaging. (b) Multi-frame sequences with 5 ns exposure times

94 showing 15-µm Al particle impacts on Zn substrate (top) and Al substrate (bottom) at 940 m/s and 950 95 m/s (resp.) impact velocity. The micro-projectile arrives from the top of the field of view. It rebounds 96 after impacting on Zn, but adheres to Al. (c) Coefficient of restitution for Al microparticle impacts on Al 97 and Zn as well as Zn microparticle impacts on Zn. The coefficient of restitution is equal to zero above the 98 critical velocity.

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100 This is an anomalous finding and somewhat unexpected in light of the normal behavior of the Al-Al and Zn-Zn data. Site-specific observations of such impacts enable us to make a one-to-one correspondence 101 between impact residue and the recorded impact event in the  $\sim 10$  ns-10  $\mu$ m-1 km/s time-size-velocity 102 103 parameter space. The scanning electron microscope (SEM) images, shown in the left column of Fig. 2, correspond to three impressions left behind after impacts of Al particles on Zn substrates at 930, 1195, 104 and 1368 m/s. An impact at 930 m/s left an appreciable indentation behind. The surface morphology 105 inside the indentation is similar to that of the undeformed substrate outside; the substrate has been 106 deformed plastically but not melted and resolidified. With further increase in impact velocity, a ring with 107 108 a netlike structure—a signature of melting and rupture through a Rayleigh-Taylor instability [29] emerged close to the indentation edge. Energy dispersive spectroscopy (EDS) analysis (see Fig. SM2 in 109 Supplemental Material [28]) of the impacted area confirmed that the netlike structure consists of Zn 110 111 substrate only, with no measurable contribution from the Al particle. In other words, it is the Zn substrate that undergoes melting and re-solidification, and not the Al particle, in line with the fact that Zn has a 112 lower melting temperature than Al (693 vs. 933 K). The ring is only partial at the lower impact velocity 113 114 but complete at the higher velocity. Interestingly, the impact velocity range causing melting is the same for which we observed the plateau of low but nonzero CoR values in Fig. 1(c). 115

Based on these observations, we propose that the anomalous lack of adhesion in this case is caused by the 116 117 emergence of melting, which hinders impact-induced adhesion. To further confirm this, we conducted the same experiments with the same Al microparticles but with a Sn substrate. Because of its lower specific 118 heat and melting temperature, we expected Sn to be more susceptible to melting than Zn in our 119 120 microparticle impact events. SEM images in the right column of Fig. 2 show three indentations on a Sn surface with increasing impact velocities. The same trend holds for this situation, albeit at much lower 121 impact velocities for Sn than for Zn (by about 500 m/s) as expected. At 1128 m/s the entire impact region 122 underwent melting and re-solidification; it is interesting that even a high-velocity impact producing such a 123 large extent of melting could not lead to the adhesion of the impacting particle on the substrate. 124

125 While we cannot rule out a possible second change in behavior that admits adhesion at velocities above 126 the range we are able to study here, the trends in the data suggest that more extensive melting does nothing to improve adhesion. This is in spite of the fact the that melting should promote chemical 127 interactions between particle and substrate; whereas there is little solid solubility between these 128 mismatched pairs, in the liquid Al-Zn is fully miscible and Al-Sn attains full miscibility if there is 129 sufficient superheat in the liquid [30]. Similarly, the surface energy of Al is  $1.16 \text{ J/m}^2$ , and that of both Zn 130 131  $(0.99 \text{ J/m}^2)$  and Sn  $(0.7 \text{ J/m}^2)$  are much lower [31], which should correlate with a significant tendency to chemical mixing. Thus, as we increase the velocity to 1.4 times the threshold for melting in Al-Zn, we 132 expect more chemical interaction that would favor bonding, but see no hint of adhesion. In the case of 133 134 Al-Sn it is even more stark: even at velocities up to 2.25 times the melting onset, we find no cases of 135 adhesion.



FIG. 2. SEM observation of Al microparticle supersonic impact induced-indentations on Zn substrate at 930 (a) 1195 (b) and 1368 (c) m/s velocities along the impact induced-indentations on Sn at 545 m/s (d), 737 (e) and 1128 (f) m/s velocities. Even though the substrate melted at increasing impact velocities, melting clearly did not lead to adhesion.

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143 These observations, far from supporting impact-induced melting as an adhesion mechanism, suggest the opposite; melting hinders adhesion in these experiments. Whereas melting fuses materials in welding [32] 144 and bonds coatings to substrates during thermal spraying [33], it can oppose adhesion in supersonic 145 146 microparticle impact. We attribute this effect to the short timescales of supersonic adhesion. If an impacting particle resides on the top of a molten surface layer of a substrate for a long enough time, it 147 should eventually fuse to the substrate thanks to chemical mixing and the molten layer resolidifying. In 148 supersonic impact, however, the residence time of the particle on the substrate is limited. If the time 149 needed for solidification is longer than the residence time of the particle, it will rebound with no 150 151 mechanical resistance from the adjacent unsolidified liquid.

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For an order-of-magnitude-analysis, the residence time of the particle can be estimated with the characteristic time for a high velocity impact:

$$t_r = \frac{d}{V_i} \tag{1}$$

with *d* being the diameter of the particle and  $V_i$  the impact velocity. The solidification time for a thin molten layer of volume  $v_{melt}$  limited by heat conduction of the latent heat of fusion, H<sub>f</sub>, out through an area *A* to the bulk of the substrate can be estimated using Chvorinov's rule, [34]:

$$t_{s} = \left[\frac{H_{f}}{(T_{m} - T_{0})}\right]^{2} \left[\frac{\rho_{s}\pi}{4KC}\right] \left(\frac{\nu_{melt}}{A}\right)^{2}$$
(2)

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where  $T_m$  is the melting temperature,  $T_0$  is ambient, *K* is the thermal conductivity of the substrate,  $\rho_s$  is the density of the substrate, and *C* is the specific heat. In this analysis, for simplicity we neglect possible superheating and changes in properties of the substrate at melting.

165 We approximate the surface area of the melt with  $A = \pi d/4^2$  and employ an energy scaling relationship to 166 estimate the amount of molten material produced by a hypervelocity impact following [35].

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$$\frac{\rho_s v_{melt}}{m_p} = k \left(\frac{V_i^2}{E_m}\right)^{3\mu/2} \tag{3}$$

168

169 where  $m_p$  is the mass of the particle, k and  $\mu$  are scaling parameters whose values have been constrained 170 empirically [36,37], and  $E_m$  is the energy of the Rankine-Hugoniot state from which an adiabatic 171 decompression would end on the liquidus at 1 atm (see Supplemental Material [28] which includes 172 Refs [38,39]).

In Fig. 3, we compare the solidification time for the melt induced by an impact of a 14-µm Al particle 173 with the residence time of the particle at different impact velocities. We present the curves for Zn and Sn 174 175 only for impact velocities beyond the corresponding threshold velocity of melting (~1000 and ~500 m/s respectively) to keep the solidification time analysis relevant. At the threshold velocity for melting, the 176 solidification time in both cases is at least two orders of magnitude higher than the residence time; the 177 molten surface layer is unable to solidify (and thereby contribute to adhesion) during the time the particle 178 179 is in contact with the substrate. At higher impact velocities the residence time only decreases, while the 180 solidification time rises, leading to very significant differences between the two parameters. At 1000 m/s, for instance, the solidification times for both Zn and Sn are in the µs regime whereas the residence time 181 182 remains in the ns regime. Since the residence and solidification times are diverging at higher velocities in Fig. 3, this model suggests that it is unlikely that adhesion occurs at higher impact velocities beyond those 183 184 explored in the present work.

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Setting the residence time equal to the solidification time leads to a potential domain where there could bea cross-over between the two:

$$\left\{\frac{\pi k^2 \rho_p^2}{9KC \rho_s E_m^{3\mu}} \left(\frac{H_f}{T_m - T_0}\right)^2\right\} V_i^5 d = 1$$
(4)

190 Equation (4) gives the locus of this crossover in the particle size-impact velocity space, with the amplitude in braces being a function of substrate properties and particle density,  $\rho_p$ . We predict based on 191 192 Eq. (4) that for much smaller (submicron) particles the residence time might be long enough to accommodate solidification while the particle is in contact, which might in turn facilitate adhesion ( $t_{\rm R}$  > 193  $t_s$ ) (see Fig. SM3 in Supplemental Material [28]). Although with our current platform it would be 194 195 possible to launch submicron particles, such particle sizes are below the resolution of our imaging system and we would not be capable of tracking them or measuring their velocities. We offer this as a direction 196 197 for future work on this topic. Although the adhesion energy does not significantly differ from one metal to another, one may also study different materials for particle and substrate to examine potential effects of 198 199 the chemical nature between the two interacting materials.

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FIG. 3. Comparison of residence time of a 14-µm Al particle with the solidification time of the impactinduced melt in Zn and Sn substrates. The solidification time for impact-induced melting by microparticles can be orders of magnitude longer than the residence time.

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To summarize, our *in-situ* and post-mortem observations of supersonic micro-particle impact offer a contrary viewpoint to widely postulated benefits of localized melting in impact-induces adhesion: For  $\sim 10$ µm particles, when an impact provides enough energy to melt the indent area, whether partially or fully, adhesion is found to be hindered; the low mechanical strength of the liquid interface is easily overcome by a rapidly rebounding particle if solidification is too slow to provide a solid-state joint. Such resolidification is estimated to take orders of magnitude longer than the time that the particle resides on the substrate. This mechanistic finding should prove useful for a broader understanding of impact-induced

adhesion, and particularly for the design of impact-based additive manufacturing processes.

215

#### 216 Acknowledgment

This work was supported by the U.S. Army through the Institute for Soldier Nanotechnologies. Funding
was provided (in part) by the Army Research laboratory (Materials Manufacturing Technology Branch:
RDRL-WMM-D) and by the U.S. Army Research Office, under Grant W911NF-13-D-0001. Support was

- also provided through Office of Naval Research DURIP Grant No. N00014-13-1-0676.
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   microparticle impacts on Sn, EDS analysis, calculations of the energy term for melt volume
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